Amendments to the Claims:

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

1. (Currently Amended) A metal identification platelet ~~(1)~~ equipped with an identification code, ~~characterized by the fact, that~~ wherein the identification code comprises a hologram ~~(2)~~.

2. (Currently Amended) The metal identification platelet ~~(1)~~ as in Claim 1, ~~characterized by the fact, that~~ wherein the identification code further comprises a passage shape hole ~~(3)~~, and/or the identification code is constituted by an external shape of the platelet ~~(1)~~.

3. (Currently Amended) The metal identification platelet ~~(1)~~ as in Claim 2, ~~characterized by the fact, that~~ wherein the hologram ~~(2)~~ and/or shape hole ~~(3)~~ comprises ~~of~~ an alphanumeric character~~s~~.

4. (Currently Amended) The metal identification platelet ~~(1)~~ as in ~~any of the~~ Claim~~s~~ 1 ~~to 3~~, ~~characterized by the fact, that~~ wherein the metal ~~used~~ is nickel, with a thickness of 1 to 15 μm ~~thick~~.

5. (Currently Amended) A method of producing an identification platelet ~~(1)~~ with ~~the~~ an identification code, ~~characterized by the fact, that it comprises the following steps~~ the method comprising:

forming a shield ~~(9)~~ from an electro-insulation material ~~is formed~~ on a shim ~~(4)~~ with a holographic motif ~~(7)~~,

then, galvanizing the shim (4) ~~is galvanized~~ in ~~the~~ places not covered by the shield ~~(9)~~ from the electro-insulation material, and

~~and~~ removing the completed metal identification platelets ~~(1) are removed~~ from the shim ~~(4)~~.

6. (Currently Amended) The method as in Claim 5, ~~characterized by the fact, that~~ wherein forming the shield ~~(9)~~ from the electro-insulation material ~~is produced in the following way~~ comprises:

applying a photoresist layer ~~(5) is applied~~ on the shim ~~(4)~~ with a holographic motif ~~(7)~~,

then putting a mask ~~(6) is put~~ on the photoresist layer ~~(5)~~, ~~and~~

exposing the photoresist layer ~~(5)~~ with the mask ~~(6) is exposed~~ by a UV lamp, ~~and~~

etching the exposed photoresist layer ~~(5) is etched~~ from the shim ~~(4)~~ in a developer,

~~than~~ then galvanizing the shim ~~(4) is galvanized~~ in the places where the photoresist layer ~~(5)~~ was etched,

removing the waste photoresist layer ~~(5) is removed~~, and

~~and~~ taking ~~the~~ completed metal identification platelets ~~(1) are taken~~ from the shim ~~(4)~~.

7. (Currently Amended) The method as in Claim 5 ~~or 6~~, ~~characterized by the fact, that~~ further comprising passivating the shim ~~(4) is passivated~~ by ~~the~~ a solution of potassium dichromate.

8. (Currently Amended) The method as in ~~any of the~~ Claim~~s~~ 6 ~~to 7~~, ~~characterized by the fact, that~~ wherein the mask comprises a printing film ~~is used as the mask (6)~~.

9. (Currently Amended) The method as in ~~any of the~~ Claim~~s~~ 5 ~~to 8~~, ~~characterized by the fact, that~~ wherein the shim ~~(4)~~ is galvanized in a galvanic-plastic nickel bath.

10. (Currently Amended) The method as in ~~any of the~~ Claim~~s~~ 5 ~~to 9~~, ~~characterized by the fact, that~~ further comprising:

removing the ~~waste~~ shield ~~(9)~~ from the electro-insulation material and/or waste photoresist layer ~~(5) is removed~~ by washing in a solvent, and

then washing the shim ~~(4) is washed~~ in ~~demineralised~~ demineralized water and ~~dried~~ drying the shim.

11. (Currently Amended) The method as in ~~any of the~~ Claim~~s~~ 5 ~~to 10~~, ~~characterized by the fact, that~~ further comprising removing the completed metal identification platelet~~s (1) are removed~~ from the shim ~~(4)~~ by fine scraping or in an ultrasonic bath.

12. (Currently Amended) The method as in ~~any of the~~ Claim~~s~~ 5 ~~to 11~~, ~~characterized by the fact, that~~ wherein the shim ~~(4)~~ with the holographic motif ~~(7)~~ is made from nickel.

13. (Currently Amended) The method as in Claim 5, ~~characterized by the fact, that~~ further comprising applying the shield ~~(9)~~ from the electro-insulation material ~~is applied~~ directly on the shim ~~(4)~~ with the holographic motif ~~(7)~~ using a printing method.

14. (Currently Amended) The method as in Claim 13, ~~characterized by the fact, that~~ further comprising applying the shield ~~(9)~~ from the electro-insulation material ~~is applied~~ using the method of intaglio printing.